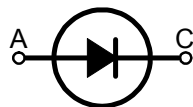


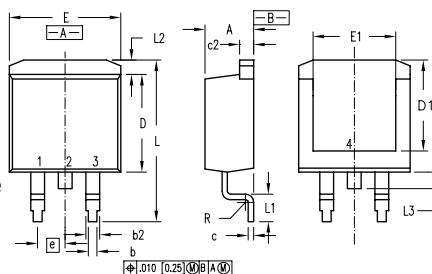
SUR1560S

Soft Recovery Behaviour Ultra Fast Recovery Epitaxial Diodes

C(TAB)



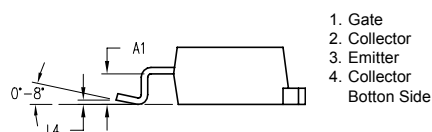
Dimensions TO-263(D²PAK)



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.06	4.83	.160	.190
A1	2.03	2.79	.080	.110
b	0.51	0.99	.020	.039
b2	1.14	1.40	.045	.055
c	0.46	0.74	.018	.029
c2	1.14	1.40	.045	.055
D	8.64	9.65	.340	.380
D1	8.00	8.89	.315	.350
E	9.65	10.29	.380	.405
E1	6.22	8.13	.245	.320
e	2.54 BSC		.100 BSC	
L	14.61	15.88	.575	.625
L1	2.29	2.79	.090	.110
L2	1.02	1.40	.040	.055
L3	1.27	1.78	.050	.070
L4	0	0.20	0	.008
R	0.46	0.74	.018	.029

A=Anode, NC= No connection, TAB=Cathode

	V _{RSM}	V _{RRM}
	V	V
SUR1560S	600	600



1. Gate
2. Collector
3. Emitter
4. Collector Bottom Side

Symbol	Test Conditions	Maximum Ratings	Unit
I _{FRMS}	T _{VJ} =T _{VJM}	25	A
I _{FAVM}	T _C =100°C; rectangular, d=0.5	15	
I _{FRM}	t _p <10us; rep. rating, pulse width limited by T _{VJM}	150	
I _{FSM}	T _{VJ} =45°C	t=10ms (50Hz), sine	A
		t=8.3ms (60Hz), sine	
	T _{VJ} =150°C	t=10ms(50Hz), sine	
		t=8.3ms(60Hz), sine	
I ² t	T _{VJ} =45°C	t=10ms (50Hz), sine	A ² s
		t=8.3ms (60Hz), sine	
	T _{VJ} =150°C	t=10ms(50Hz), sine	
		t=8.3ms(60Hz), sine	
T _{VJ}		-40...+150	°C
T _{VJM}		150	
T _{stg}		-40...+150	
P _{tot}	T _C =25°C	62	W
M _d	Mounting torque	0.4...0.6	Nm
Weight		2	g



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Symbol	Test Conditions	Characteristic Values		Unit
		typ.	max.	
I_R	$T_{VJ}=25^{\circ}\text{C}; V_R=V_{RRM}$		50	μA
	$T_{VJ}=25^{\circ}\text{C}; V_R=0.8 \cdot V_{RRM}$		25	μA
	$T_{VJ}=125^{\circ}\text{C}; V_R=0.8 \cdot V_{RRM}$		3	mA
V_F	$I_F=16\text{A}; T_{VJ}=150^{\circ}\text{C}$		1.5	V
	$T_{VJ}=25^{\circ}\text{C}$		1.7	
V_{TO}	For power-loss calculations only		1.12	V
r_T	$T_{VJ}=T_{VJM}$		23.2	$\text{m}\Omega$
R_{thJC} R_{thCK} R_{thJA}		0.5	2	K/W
			60	
t_{rr}	$I_F=1\text{A}; -di/dt=200\text{A}/\mu\text{s}; V_R=30\text{V}; T_{VJ}=25^{\circ}\text{C}$	35	50	ns
I_{RM}	$V_R=100\text{V}; I_F=60\text{A}; -di_F/dt=200\text{A}/\mu\text{s}; L \leq 0.05\mu\text{H}; T_{VJ}=100^{\circ}\text{C}$	4	4.4	A

FEATURES

- * International standard package JEDEC TO-263
- * Glass passivated chips
- * Very short recovery time
- * Extremely low switching losses
- * Low I_{RM}-values
- * Soft recovery behaviour
- * RoHS compliant

APPLICATIONS

- * Antiparallel diode for high frequency switching devices
- * Antisaturation diode
- * Snubber diode
- * Free wheeling diode in converters and motor control circuits
- * Rectifiers in switch mode power supplies (SMPS)
- * Inductive heating and melting
- * Uninterruptible power supplies (UPS)
- * Ultrasonic cleaners and welders

ADVANTAGES

- * High reliability circuit operation
- * Low voltage peaks for reduced protection circuits
- * Low noise switching
- * Low losses
- * Operating at lower temperature or space saving by reduced cooling



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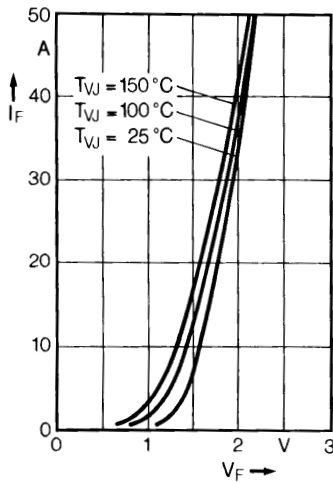


Fig. 1 Forward current versus voltage drop.

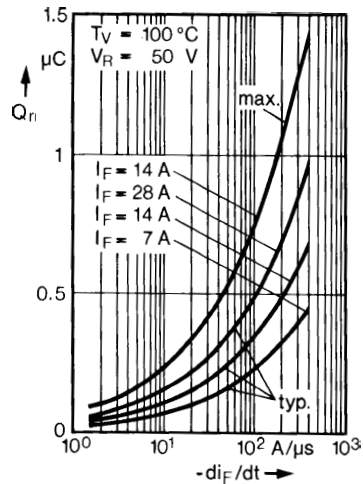


Fig. 2 Recovery charge versus $-di_F/dt$.

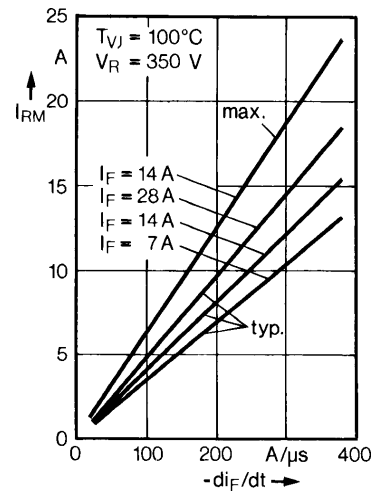


Fig. 3 Peak reverse current versus $-di_F/dt$.

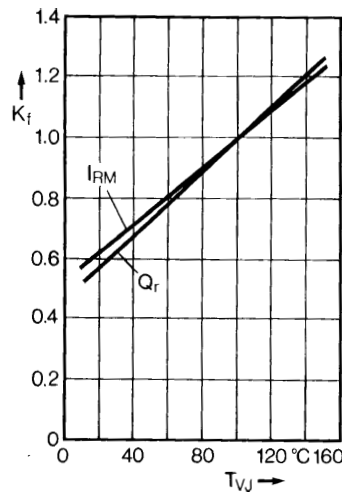


Fig. 4 Dynamic parameters versus junction temperature.

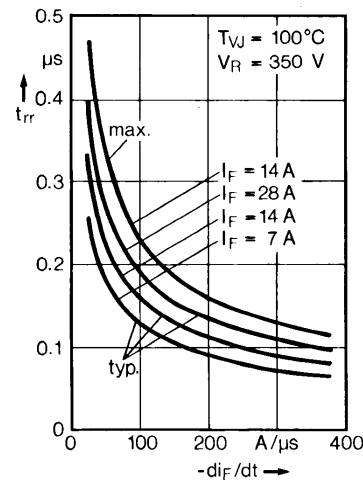


Fig. 5 Recovery time versus $-di_F/dt$.

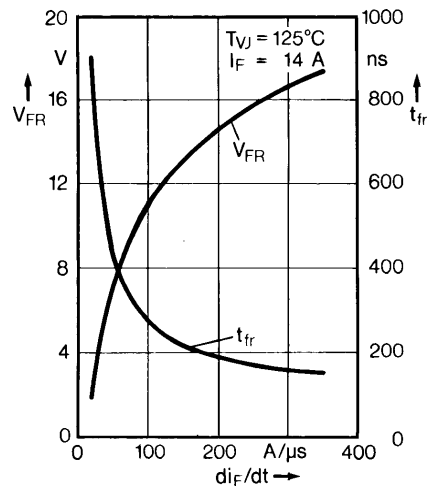


Fig. 6 Peak forward voltage versus di_F/dt .

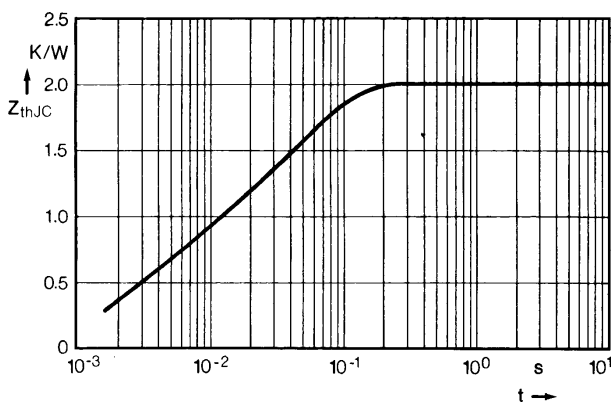


Fig. 7 Transient thermal impedance junction to case.

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